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LOC DIST

REVISIONS

P LTR

DESCRIPTION

DATE

DWN

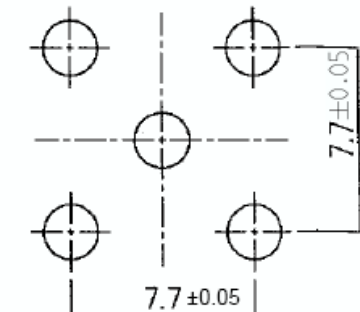
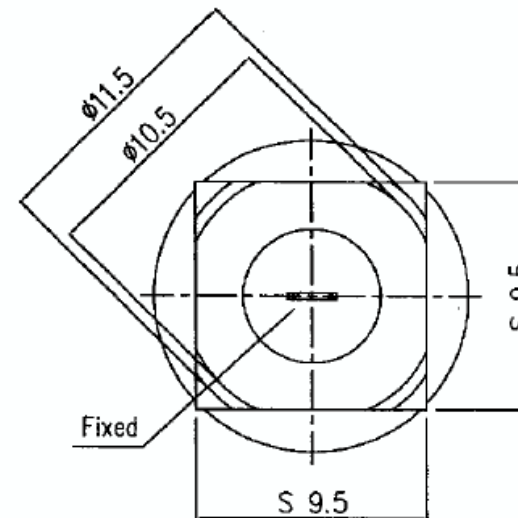
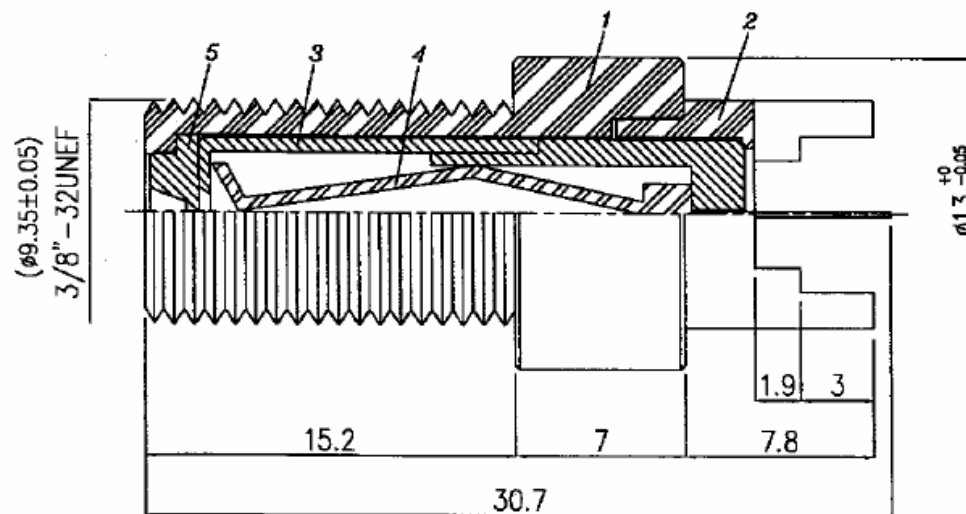
APVD

Plating changed

16.12.08

B

DB



- 1.) Connector shall meet requirement of IEC 61169-24
- 2.) Connector RoHS complaint, Directive 2002/95/EC
- 3.) Wave solder compliance with lead free solder paste in accordance to IPC / JEDEC Standard: JESD22-B106D
- 4.) Plating housing interface: Min. 2µm Ni
- 5.) Plating housing PCB: Min. 3µm tin
- 6.) Plating center contact: Min. 0.2µm Au

QTY	QTY	No	Description	Material	Plating
1	1	1	Housing Interface	Brass	4.)
1	1	2	Housing PCB	Brass	5.)
1	1	3	Dielectric	PP	-
1	1	4	Center Contact	Phosphor bronze	6.)
1	-	5	Waterproof seal, black	Silicon	-
-	1	5	Waterproof seal, orange	Silicon	-
619374-1		619374-2	← Connector Part Number		

THIS DRAWING IS A CONTROLLED DOCUMENT FOR TYCO ELECTRONICS CORPORATION
IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION
SHOULD BE CONTACTED FOR THE LATEST REVISION.

DIMENSIONS:



MATERIAL

TOLERANCES UNLESS
OTHERWISE SPECIFIED:0 PLC
1 PLC
2 PLC
3 PLC
4 PLC
ANGLES
DIN ISO
2768mH

FINISH

DWN

CHK D. Bozzer, 11.6.08

APVD

PRODUCT SPEC

108-71082

APPLICATION SPEC

WEIGHT

Tyco Electronics

NAME

F Jack PCB Solder

SIZE

CAGE CODE

DRAWING NO

RESTRICTED TO

A3

00779

C=

619374

SCALE 10:1

SHEET 1 OF 1

REV B